

# DRD8880H22

## **Rectifier Diode**

DS6006-1 March 2011 (LN28193)

## **FEATURES**

- Double Side Cooling
- High Surge Capability

## **KEY PARAMETERS**

 $\begin{array}{ll} V_{\text{RRM}} & 2200V \\ I_{\text{F(AV)}} & 8880A \\ I_{\text{FSM}} & 125000A \end{array}$ 

#### **VOLTAGE RATINGS**

Part and Ordering Number	Repetitive Peak Voltages V <sub>RRM</sub> V	Conditions
DRD8880H22 DRD8880H20 DRD8880H18 DRD8880H16	2200 2000 1800 1600	$V_{RSM} = V_{RRM} + 100V$

#### **ORDERING INFORMATION**

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

DRD8880H22 for a 2200V device

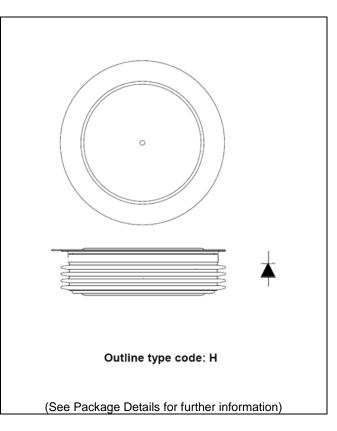


Fig. 1 Package outline



## **CURRENT RATINGS**

#### $T_{case} = 75$ °C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units			
Double Si	Double Side Cooled						
I <sub>F(AV)</sub>	Mean forward current	Half wave resistive load	11150	А			
I <sub>F(RMS)</sub>	RMS value	-	17510	А			
I <sub>F</sub>	Continuous (direct) on-state current	-	15770	Α			

## T<sub>case</sub> = 100°C unless stated otherwise

Symbol	Parameter	Test Conditions		Units			
Double Si	Double Side Cooled						
I <sub>F(AV)</sub>	Mean forward current	Half wave resistive load	8880	А			
I <sub>F(RMS)</sub>	RMS value	-	13940	А			
I <sub>F</sub>	Continuous (direct) on-state current	-	12560	А			

## **SURGE RATINGS**

Symbol	Parameter	Test Conditions	Max.	Units
I <sub>FSM</sub>	Surge (non-repetitive) on-state current	10ms half sine, T <sub>case</sub> = 160°C	125.0	kA
l <sup>2</sup> t	I <sup>2</sup> t for fusing	$V_R = 0$	78.13	MA <sup>2</sup> s



## THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Conditions	5	Min.	Max.	Units
R <sub>th(j-c)</sub>	Thermal resistance – junction to case	Double side cooled	DC	-	0.004	°C/W
R <sub>th(c-h)</sub>	Thermal resistance – case to heatsink	Double side cooled	DC	-	0.0008	°C/W
T <sub>vj</sub>	Virtual junction temperature	Blocking V <sub>DRM</sub> / <sub>VRRM</sub>		-40	160	°C
T <sub>stg</sub>	Storage temperature range			-40	160	°C
F <sub>m</sub>	Clamping force			110	130	kN

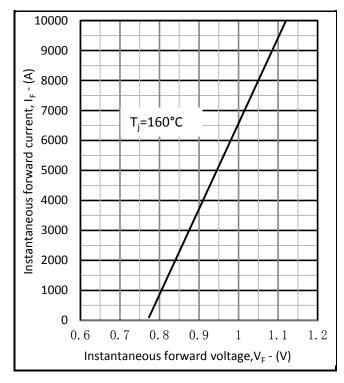
## **CHARACTERISTICS**

Symbol	Parameter	Test Conditions	Min.	Max.	Units
V <sub>FM</sub>	Forward voltage	At 6000A peak, T <sub>case</sub> = 160°C	-	0.98	V
I <sub>RM</sub>	Peak reverse current	At V <sub>DRM</sub> , T <sub>case</sub> = 160°C	-	600	mA
Q <sub>S</sub>	Total stored charge	$I_F = 4000A$ , $dI_{RR}/dt = 10A/\mu s$ $T_{case} = 160^{\circ}C$ , $V_R = 100V$	-	8000	μC
V <sub>TO</sub>	Threshold voltage	At T <sub>vj</sub> = 160°C	-	0.77	V
r <sub>T</sub>	Slope resistance	At T <sub>vj</sub> = 160°C	-	0.035	mΩ

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#### **CURVES**



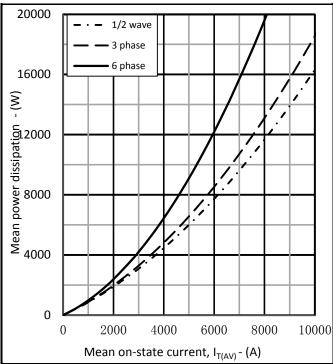
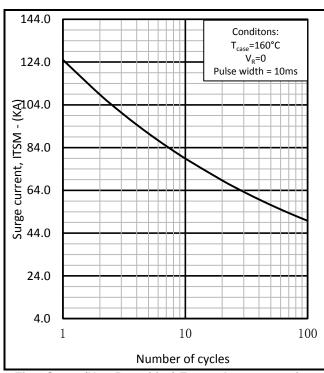
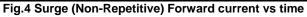


Fig.2 Maximum forward characteristics







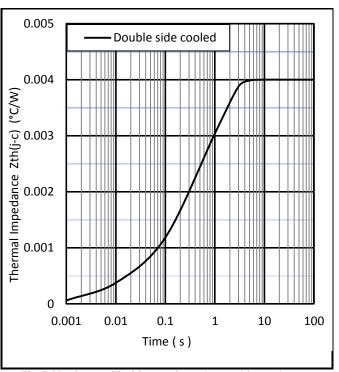
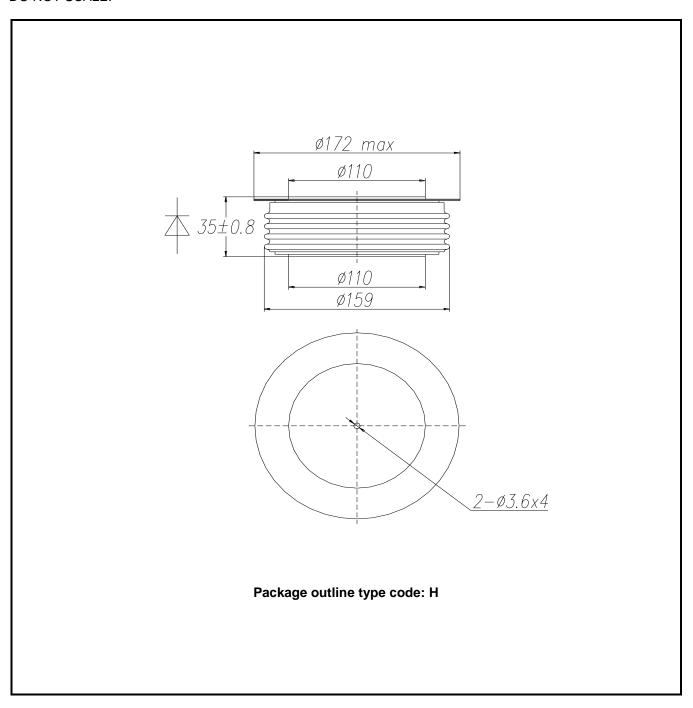


Fig.5 Maximum (limit) transient thermal impedancejunction to case



## **PACKAGE DETAILS**

For further package information, please contact Customer Services. All dimensions in mm, unless stated otherwise. DO NOT SCALE.



#### Note:

Some packages may be supplied with gate and or tags.

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Extended exposure to conditions outside the product ratings may affect reliability leading to premature product failure. Use outside the product ratings is likely to cause permanent damage to the product. In extreme conditions, as with all semiconductors, this may include potentially hazardous rupture, a large current to flow or high voltage arcing, resulting in fire or explosion. Appropriate application design and safety precautions should always be followed to protect persons and property.

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No actual design work on the product has been started.

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